

## Diode Modules

## PSKD 172

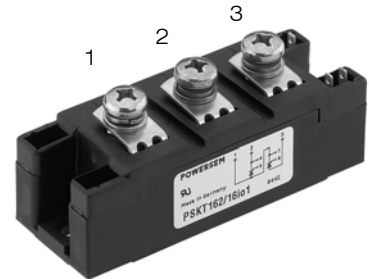
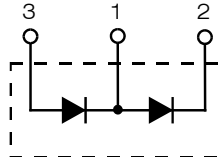
$$I_{FRMS} = 2x 300 A$$

$$I_{FAVM} = 2x 190 A$$

$$V_{RRM} = 800-1800 V$$

Preliminary Data Sheet

$V_{RSM}$ V	$V_{RRM}$ V	Type
900	800	PSKD 172/08
1300	1200	PSKD 172/12
1500	1400	PSKD 172/14
1700	1600	PSKD 172/16
1900	1800	PSKD 172/18



Symbol	Test Conditions	Maximum Ratings
$I_{FRMS}$	$T_{VJ} = T_{VJM}$	300 A
$I_{FAVM}$	$T_C = 100^\circ C$ ; 180° sine	190 A
$I_{FSM}$	$T_{VJ} = 45^\circ C$ ; $V_R = 0$	t = 10 ms (50 Hz), sine 6600 A t = 8.3 ms (60 Hz), sine 7290 A
	$T_{VJ} = T_{VJM}$ ; $V_R = 0$	t = 10 ms (50 Hz), sine 5600 A t = 8.3 ms (60 Hz), sine 6200 A
$\int i^2 dt$	$T_{VJ} = 45^\circ C$ ; $V_R = 0$	t = 10 ms (50 Hz), sine 218 000 A <sup>2</sup> s t = 8.3 ms (60 Hz), sine 221 000 A <sup>2</sup> s
	$T_{VJ} = T_{VJM}$ ; $V_R = 0$	t = 10 ms (50 Hz), sine 157 000 A <sup>2</sup> s t = 8.3 ms (60 Hz), sine 160 000 A <sup>2</sup> s
$T_{VJ}$		-40...+150 °C
$T_{VJM}$		150 °C
$T_{stg}$		-40...+125 °C
$V_{ISOL}$	50/60 Hz, RMS	t = 1 min 3000 V~
	$I_{ISOL} \leq 1 mA$	t = 1 s 3600 V~
$M_d$	Mounting torque (M6)	2.25-2.75/20-25 Nm/lb.in.
	Terminal connection torque (M6)	4.5-5.5/40-48 Nm/lb.in.
Weight	Typical including screws	120 g

### Features

- International standard package
- Direct copper bonded Al<sub>2</sub>O<sub>3</sub> -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered, E 148688

### Applications

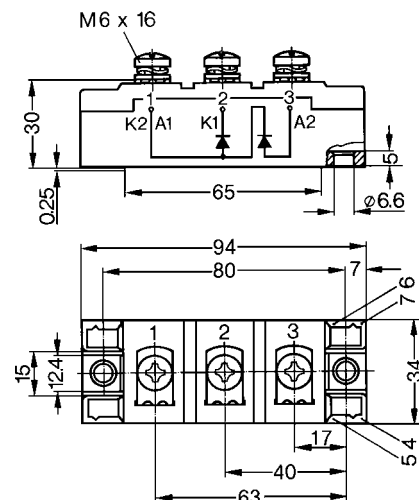
- Supplies for DC power equipment
- DC supply for PWM inverter
- Field supply for DC motors
- Battery DC power supplies

### Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Symbol	Test Conditions	Characteristic Values
$I_R$	$T_{VJ} = T_{VJM}$ ; $V_R = V_{RRM}$	20 mA
$V_F$	$I_F = 300 A$ ; $T_{VJ} = 25^\circ C$	1.15 V
$V_{TO}$	For power-loss calculations only	0.8 V
$r_T$	$T_{VJ} = T_{VJM}$	0.8 mΩ
$Q_S$	$T_{VJ} = 125^\circ C$ ; $I_F = 300 A$ , -di/dt = 50 A/μs	550 μC
$I_{RM}$		235 A
$R_{thJC}$	per diode; DC current	} other values see Fig. 6/7
	per module	
$R_{thJK}$	per diode; DC current	}
	per module	
$d_s$	Creepage distance on surface	12.7 mm
$d_A$	Strike distance through air	9.6 mm
$a$	Maximum allowable acceleration	50 m/s <sup>2</sup>

### Dimensions in mm (1 mm = 0.0394")



Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

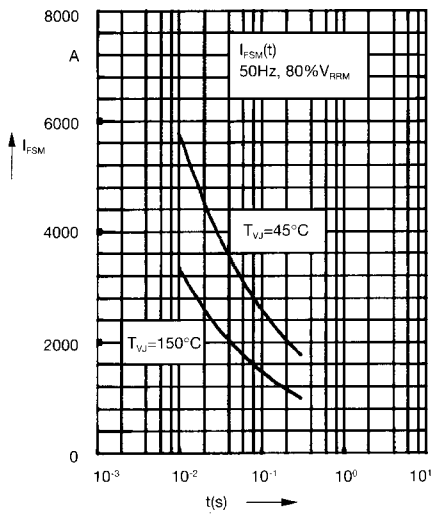


Fig. 1 Surge overload current  
 $I_{FSM}$ : Crest value,  $t$ : duration

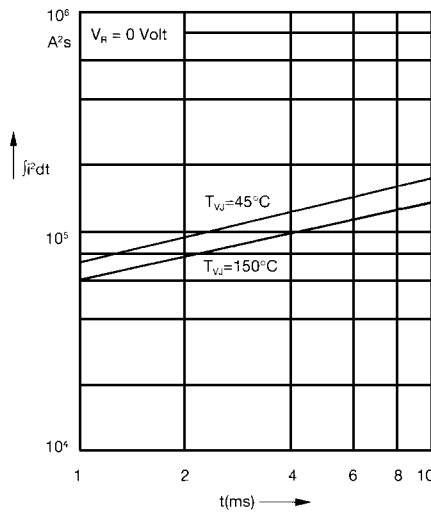


Fig. 2  $\int i^2 dt$  versus time (1-10 ms)

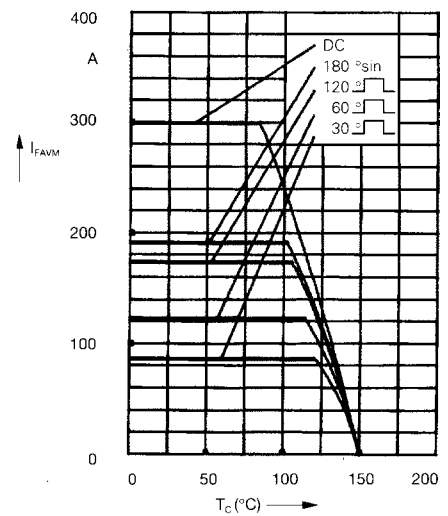


Fig. 2a Maximum forward current at case temperature

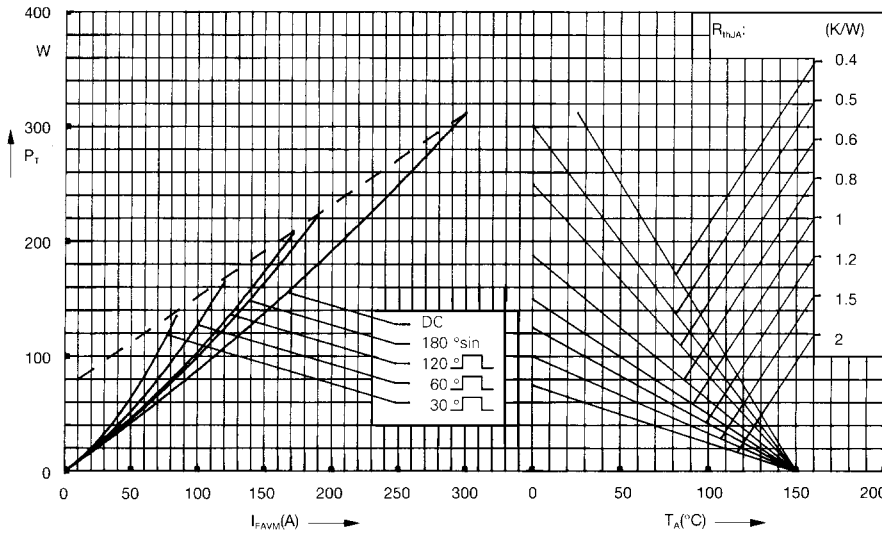


Fig. 3 Power dissipation versus forward current and ambient temperature (per diode)

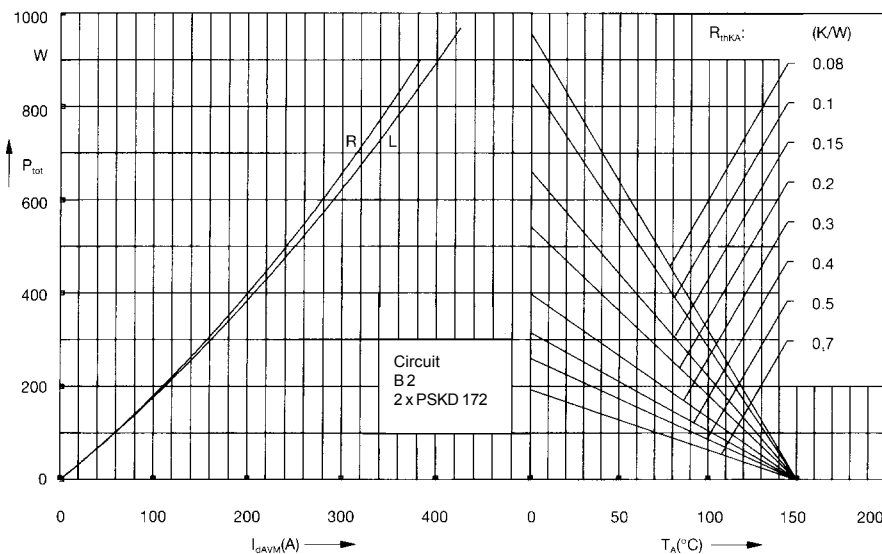


Fig. 4 Single phase rectifier bridge:  
 Power dissipation versus direct output current and ambient temperature  
 R = resistive load  
 L = inductive load

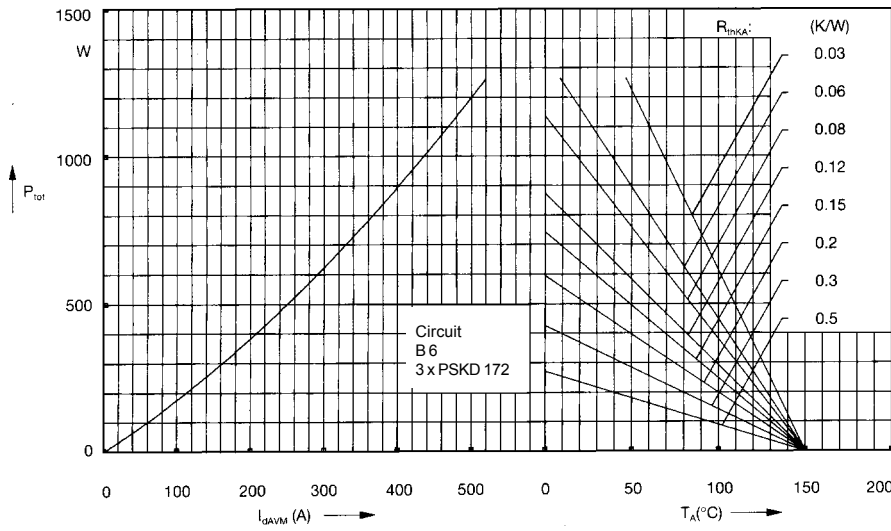


Fig. 5 Three phase rectifier bridge:  
Power dissipation versus direct  
output current and ambient  
temperature

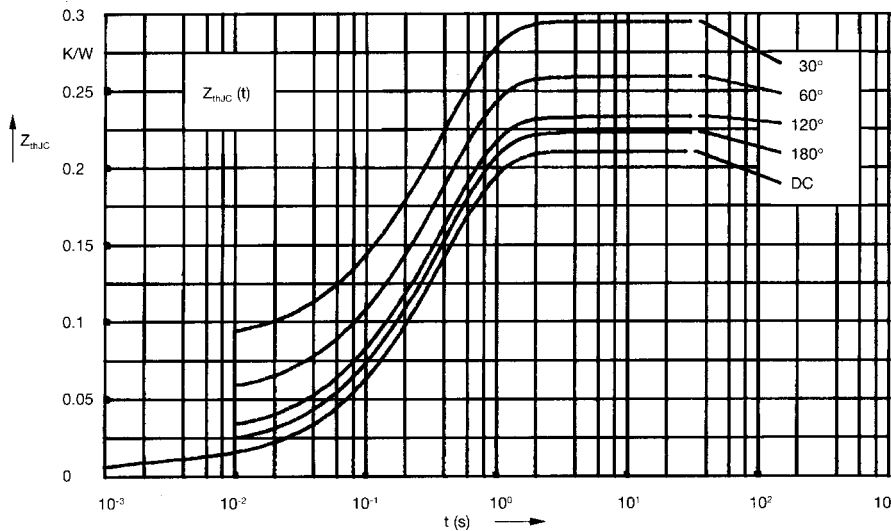


Fig. 6 Transient thermal impedance  
junction to case (per diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.210
180°	0.223
120°	0.233
60°	0.260
30°	0.295

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0087	0.001
2	0.0163	0.065
3	0.185	0.4

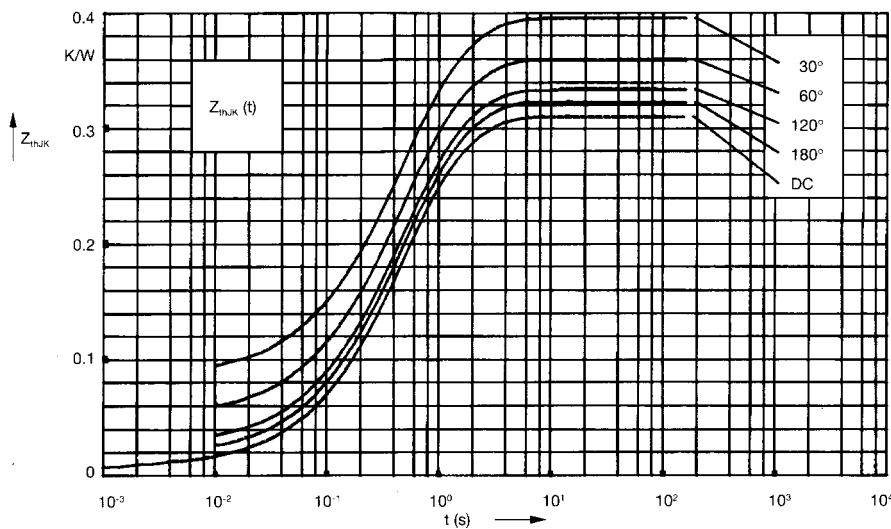


Fig. 7 Transient thermal impedance  
junction to heatsink (per diode)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.31
180°	0.323
120°	0.333
60°	0.360
30°	0.395

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0087	0.001
2	0.0163	0.065
3	0.185	0.4
4	0.1	1.29